PNP Transistor with Dual Series Switching Diode

Features

• These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- LCD Control Board
- High Speed Switching
- High Voltage Switching

MAXIMUM RATINGS - PNP TRANSISTOR

| Rating | Symbol | Value | Unit |
|--------------------------------|------------------|-------|------|
| Collector – Emitter Voltage | V _{CEO} | -80 | Vdc |
| Collector – Base Voltage | V _{CBO} | -80 | Vdc |
| Emitter – Base Voltage | V _{EBO} | -4.0 | Vdc |
| Collector Current – Continuous | Ι _C | -500 | mAdc |

MAXIMUM RATINGS - SWITCHING DIODE

| Rating | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Reverse Voltage | V _R | 100 | V |
| Forward Current | ١ _F | 200 | mA |
| $\begin{array}{l} \mbox{Non-Repetitive Peak Forward Current} \\ \mbox{(Square Wave, } T_J = 25^\circ C \mbox{ prior to} \\ \mbox{surge)} & t < 1 \mbox{ sec} \\ t = 1 \mu \mbox{sec} \end{array}$ | I _{FSM} | 1.0 20 | A |
| Operating and Storage Junction Temperature Range | T _J , T _{stg} | -55 to +150 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ESD RATINGS

| Rating | | Class | Value |
|-------------------------|-----|-------|--------------------------------|
| Electrostatic Discharge | HBM | 3A | 4000 V \leq Failure < 8000 V |
| | MM | M4 | Failure > 400 V |

THERMAL CHARACTERISTICS

| Rating | Symbol | Max | Unit |
|---|-----------------------------------|-------------|-------------|
| Total Device Dissipation FR-5 Board, (Note 1) @ T _A = 25°C Derate above 25°C | P _D | 400 | mW mW/°C |
| Thermal Resistance from Junction-to-Ambient (Note 1) | $R_{\theta JA}$ | 313 | °C/W |
| Total Device Dissipation FR-5 Board (Note 2) T _A = 25°C Derate above 25°C | P _D | 270 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient (Note 2) | $R_{\theta JA}$ | 463 | °C/W |
| Junction and Storage Temperature Range | T _J , T _{stg} | –55 to +150 | °C |

1. FR-5 = 650 mm² pad, 2.0 oz Cu.

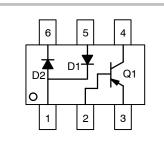
2. FR-5 = 10 mm² pad, 2.0 oz Cu.



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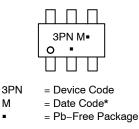
http://onsemi.com

PNP Transistor with Dual Series Switching Diode





MARKING DIAGRAM



(Note: Microdot may be in either location) *Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

| | Device | Package | Shipping [†] |
|---|--------------|--------------------|-----------------------|
| Ν | NSM80100MT1G | SC–74 (Pb–Free) | 3000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Q1: PNP TRANSISTOR

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

| Characteristic | | Symbol | Min | Max | Unit |
|--|--|----------------------|------|-------|------|
| OFF CHARACTERISTICS | | | • | | |
| Collector – Emitter Breakdown Voltage (Note 3) | (I _C = -1.0 mA, I _B = 0) | V _{(BR)CEO} | -80 | - | V |
| Emitter – Base Breakdown Voltage | $(I_{E} = -100 \ \mu A, \ I_{C} = 0)$ | V _{(BR)EBO} | -4.0 | - | V |
| Collector Cutoff Current | $(V_{CE} = -60 \text{ V}, \text{ I}_{B} = 0)$ | I _{CES} | - | -0.1 | μA |
| Collector Cutoff Current | $(V_{CB} = -80 \text{ V}, I_E = 0)$ | I _{CBO} | - | -0.1 | μΑ |
| ON CHARACTERISTICS (Note 3) | | | | | |
| DC Current Gain | (I _C = -10 mA, V _{CE} = -1.0 V) | h _{FE} | 120 | - | - |
| Collector – Emitter Saturation Voltage | (I _C = -100 mA, I _B = -10 mA) | V _{CE(sat)} | _ | -0.25 | V |
| Base – Emitter Saturation Voltage | (I _C = -100 mA, V _{CE} = -1.0 V) | V _{BE(sat)} | _ | -1.2 | V |
| SMALL-SIGNAL CHARACTERISTICS | | | | | |
| Current-Gain – Bandwidth Product (Note 4) $(I_C = -100)$ | 0 mA, V _{CE} = -2.0 V, f = 100 MHz) | f _T | 150 | _ | MHz |

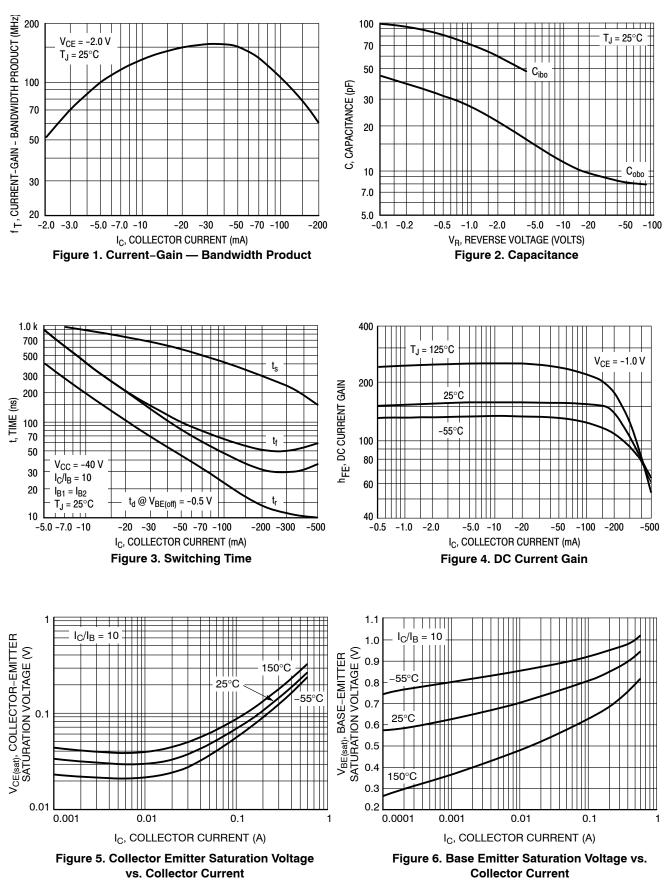
3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%. 4. fT is defined as the frequency at which $|h_{fe}|$ extrapolates to unity.

D1, D2: SWITCHING DIODE (T_A = 25° C unless otherwise noted)

| Characteristic | Symbol | Min | Max | Unit |
|---|-------------------|-------------|----------------------------|------|
| OFF CHARACTERISTICS | | | | |
| Reverse Breakdown Voltage | V _(BR) | 75 | - | V |
| Reverse Voltage Leakage Current $ \begin{array}{c} (V_R=75~V) \\ (V_R=20~V,~T_J=150^\circ C) \\ (V_R=75~V,~T_J=150^\circ C) \end{array} $ | I _R | | 1.0 30 100 | μΑ |
| Diode Capacitance $(V_{R}=0\;V,f=1.0\;MHz)$ | C _D | - | 1.5 | pF |
| Forward Voltage $\begin{array}{l} (I_F=1.0 \text{ mA})\\ (I_F=10 \text{ mA})\\ (I_F=50 \text{ mA})\\ (I_F=150 \text{ mA}) \end{array}$ | V _F | - - - | 715 855 1000 1250 | mV |
| Reverse Recovery Time $(I_F = I_R = 10 \text{ mA}, i_{R(REC)} = 1.0 \text{ mA}, R_L = 100 \ \Omega)$ | t _{rr} | - | 4.0 | ns |
| Forward Recovery Voltage (I _F = 10 mA, t_r = 20 ns) | V _{FR} | - | 1.75 | V |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

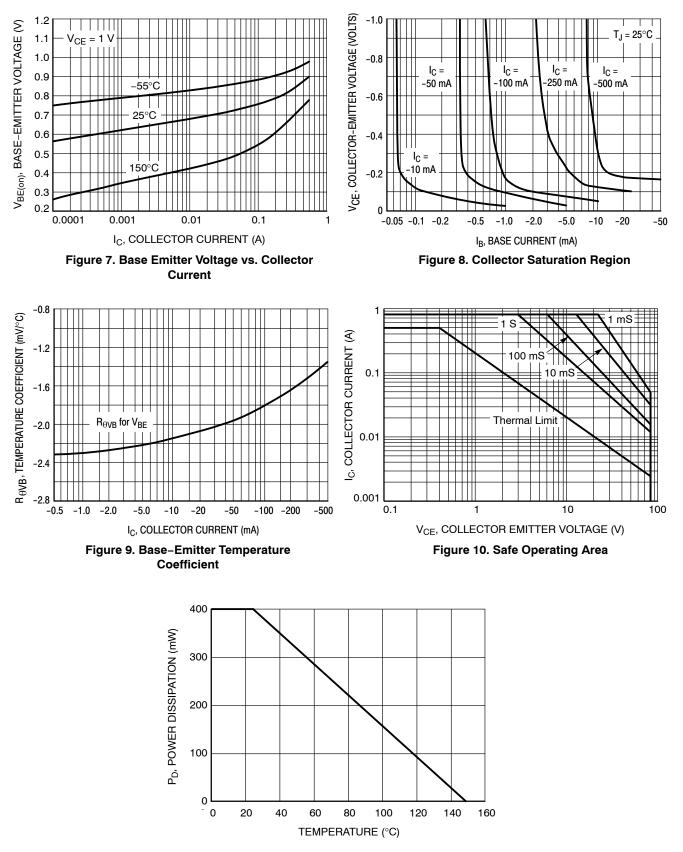
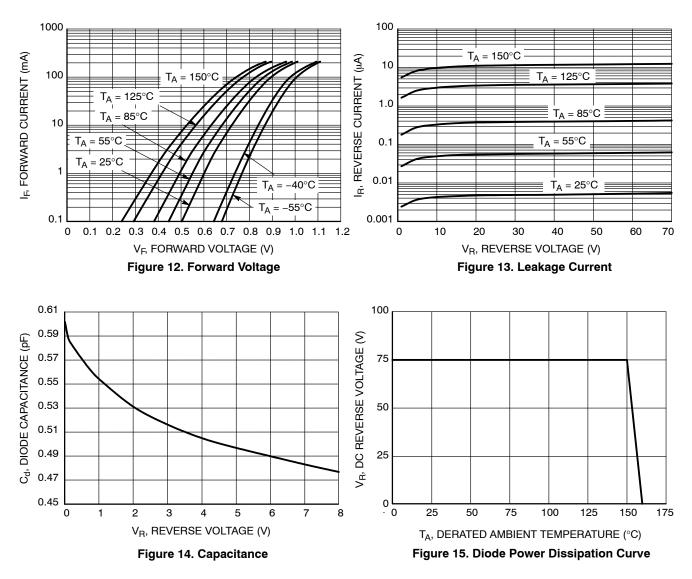


Figure 11. Operating Temperature Derating

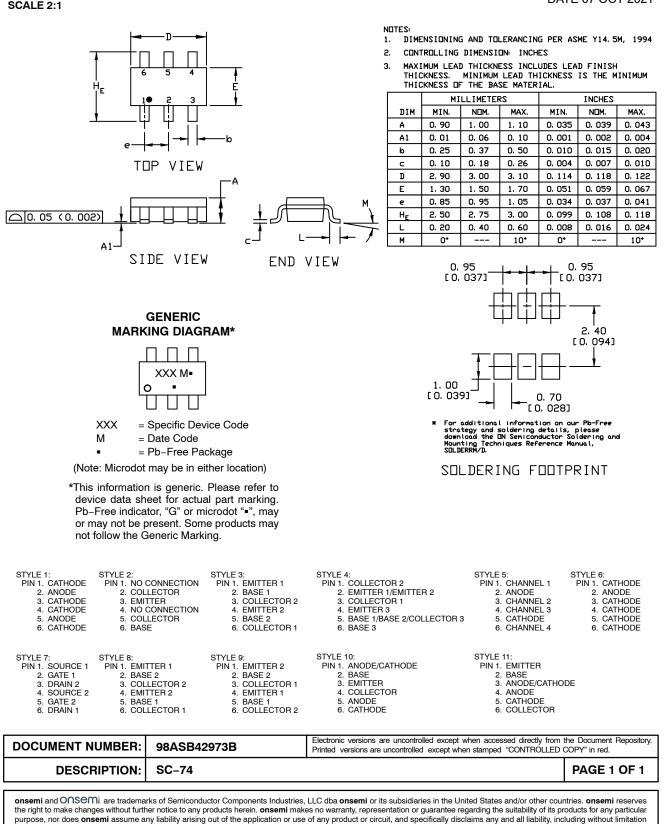
TYPICAL CHARACTERISTICS



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